As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below adjacent to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of subject matter (process, machine, manufacture, or composition of matter, or an improvement thereof) that is disclosed and/or claimed and for which a patent is solicited by way of the application entitled

METHOD AND SYSTEM FOR DEVICE-LEVEL SIMULATION OF A CIRCUIT DESIGN FOR A PROGRAMMABLE LOGIC DEVICE

which (check)			
was filed on	the Preliminary Amendme	Application Serial No	·
[] and was amended o	n	(if applicable).	
including the claims, including the claims, including the claims, including the duty to contain the claims.	ling portions amended by disclose information whicl	ne contents of the above identificant any amendment referred to all to the examination	pove.
accordance with Title 37,	Code of Federal Regulation	ons, § 1.56(a).	
application(s) for patent or foreign application for pate on which priority is claimed.	inventor's certificate listed ent or inventor's certificate d:	United States Code, § 119 of a I below and have also identifie having a filing date before tha	d below any t of the application
Prior Foreign Application(s	5)		Priority Claimed
N/A			Yes No
(Number)	(Country)	(Day/Month/Year Filed)	•
N/A (Number) N/A (Number)			Yes No
(Number)	(Country)	(Day/Month/Year Filed)	
I hereby claim the benefit used below N/A (Application Number(s))		any United States provisional	application(s)
listed below and, insofar as States application in the ma I acknowledge the duty to d	any subject matter of this unner provided by the first disclose material informat urred between the filing d	es Code, § 120 of any United Stapplication is not disclosed in application of Title 35, United ion as defined in Title 37, Code ate of the prior application(s) a	the prior United States Code, § 112, of Federal Regu-
N/A			
(Application Serial No.)	(Filing Date)	(Status-patented, pend	ing, abandoned)
N/A			
(Application Serial No.)	(Filing Date)	(Status-patented, pend	ing, abandoned)



I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the United States Patent and Trademark Office connected herewith:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18, United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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